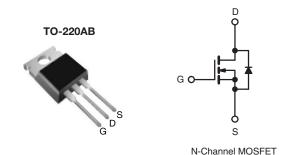


### Power MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	20	200				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	1.5				
Q <sub>g</sub> (Max.) (nC)	8	8.2				
Q <sub>gs</sub> (nC)	1	1.8				
Q <sub>gd</sub> (nC)	4	4.5				
Configuration	Sin	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Load (Dh) froe	IRF610PbF
Lead (Pb)-free	SiHF610-E3
SnPb	IRF610
SIFD	SiHF610

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	200		
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		3.3		
	VGS at 10 V	T <sub>C</sub> = 100 °C	ID	2.1	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	10		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	64	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	3.3	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.6	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	36	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s			-	300 <sup>d</sup>		
Mounting Tayous	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque			-	1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 8.8 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 3.3 \text{ A}$  (see fig. 12).
- c.  $I_{SD} \le 3.3$  A,  $dI/dt \le 70$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5		

<b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}\text{C}$ , u	nless otherw	rise noted)					
PARAMETER	SYMBOL	TEST	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	:o 25 °C, I <sub>D</sub> = 1 mA	-	0.30	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$		25	μА		
				-	-	250	μ, ,
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 2.0 \text{ A}^b$	-	-	1.5	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 5$	0 V, I <sub>D</sub> = 2.0 A <sup>b</sup>	8.0	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,	-	140	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 25 V$ ,		-	53	-	pF
Reverse Transfer Capacitance	$C_{rss}$	T = 1.01	WHz, see fig. 5	-	15	-	
Total Gate Charge	$Q_g$			1	-	8.2	
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> = 10 V		-	-	1.8	nC
Gate-Drain Charge	$Q_{gd}$		l see light called to	-	-	4.5	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.2	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 10	00 V, I <sub>D</sub> = 3.3 A,	-	17	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		-	ns		
Fall Time	t <sub>f</sub>			-	8.9	-	1
Internal Drain Inductance	$L_D$			-	4.5	-	
Internal Source Inductance	L <sub>S</sub>		nter of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	1					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	3.3	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction did	ode	-	-	10	Α
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub>	<sub>S</sub> = 3.3 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	150	310	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$J_{\rm J} = 25  ^{\circ}{\rm C},  I_{\rm F} = 3  ^{\circ}{\rm C}$	3.3 A, dl/dt = 100 A/µs <sup>b</sup>	-	0.60	1.4	μC
Forward Turn-On Time	t <sub>on</sub>	Intrincia turra	on time is negligible (turn		minatad h	v. L - and	1 \

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

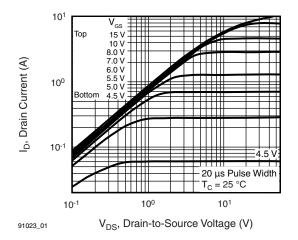


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

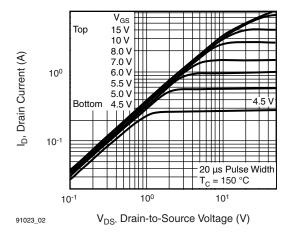


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

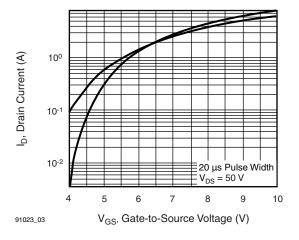


Fig. 3 - Typical Transfer Characteristics

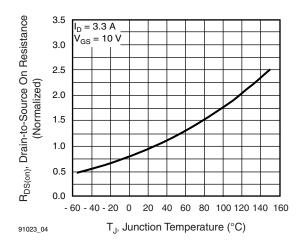


Fig. 4 - Normalized On-Resistance vs. Temperature



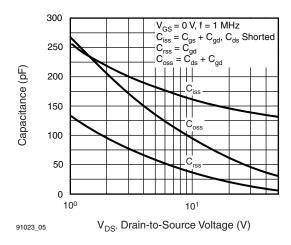


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

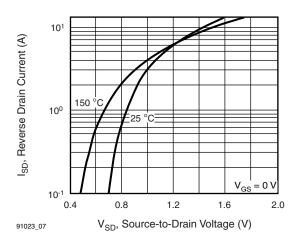


Fig. 7 - Typical Source-Drain Diode Forward Voltage

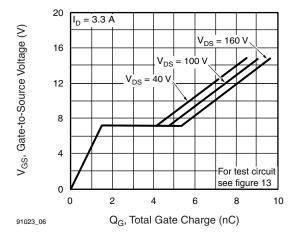


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

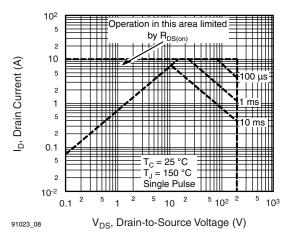
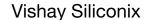


Fig. 8 - Maximum Safe Operating Area





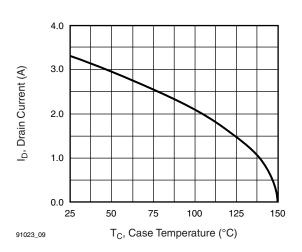


Fig. 9 - Maximum Drain Current vs. Case Temperature

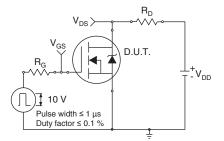


Fig. 10a - Switching Time Test Circuit

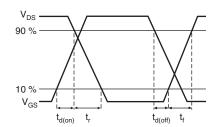


Fig. 10b - Switching Time Waveforms

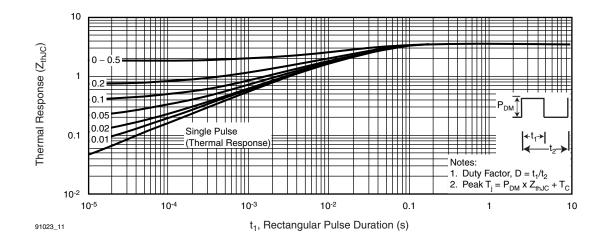


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



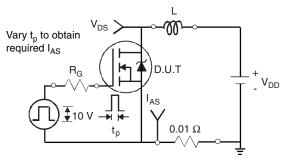


Fig. 12a - Unclamped Inductive Test Circuit

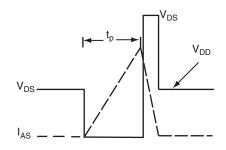


Fig. 12b - Unclamped Inductive Waveforms

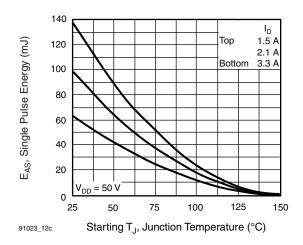


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

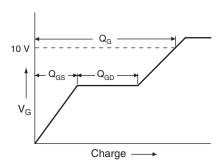


Fig. 13a - Basic Gate Charge Waveform

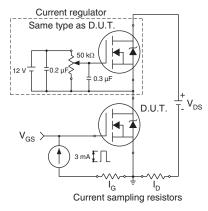
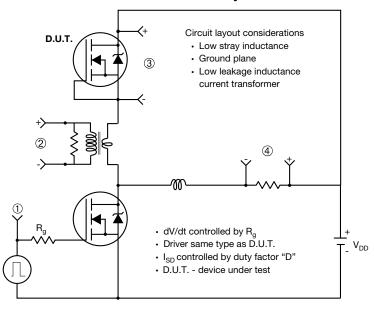


Fig. 13b - Gate Charge Test Circuit





### Peak Diode Recovery dV/dt Test Circuit



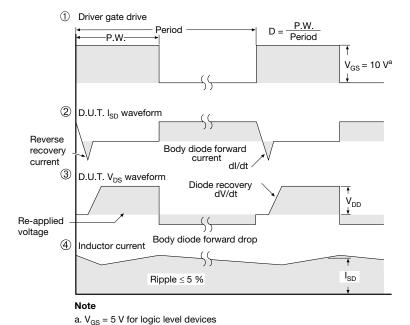


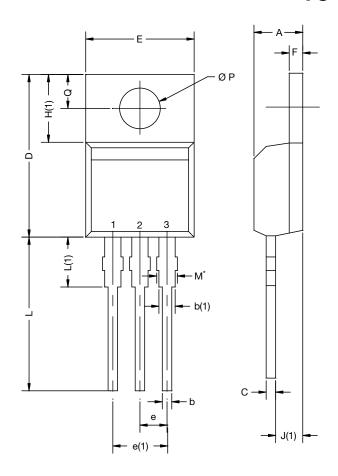
Fig. 14 - For N-Channel

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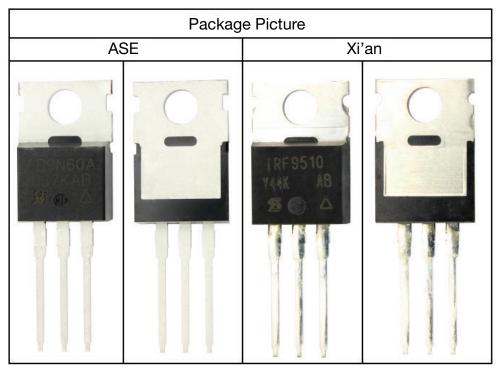
## TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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